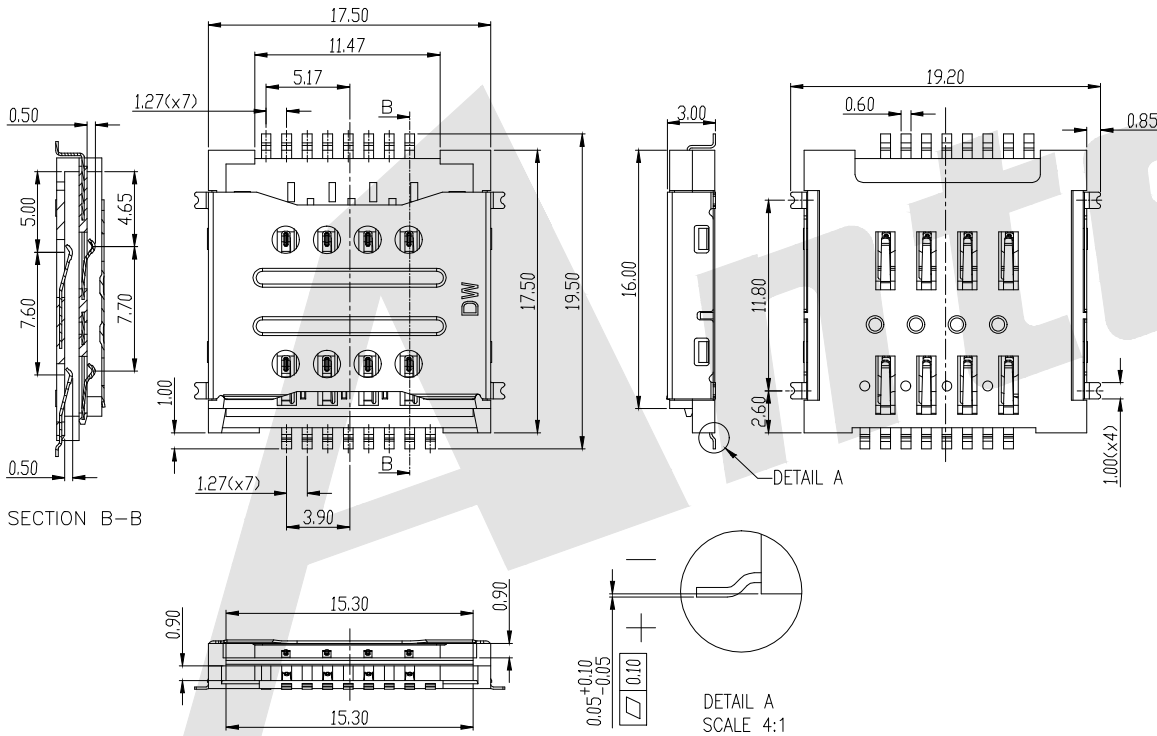


HSF



ROHS



Specification

MATERIAL:

Insulator: High Temperature Thermoplastic, UL 94V-0.
 Contact: Copper Alloy T=0.15mm
 Cap Tray: PA

PLATING:

Contact: Plated 50u'' Ni Overall Contact Au 3U, pad TIN

Electrical:

Current Rating :2Amps. max
 Voltage Rating ;5V AC/DC
 Ambient Temperature Range :-40°C~+85°C
 Storage Teperature Range :-40°C~+85°C
 Ambient Humidity Range :95% R.H. Max.
 Contact Resistance:100mΩmax.
 Insulation Resistance:1000mΩmin./500VDC
 Temperature Resistance Range: 260°C
 Mating Cycles: 5000Min Insertions

Oldering Code:

ATK - SIM - 8 - B - 300 - A - 034
 ① ② ③ ④ ⑤ ⑥

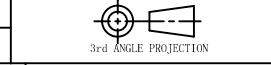
- ① Company Name:
ATK
- ② Pin Number:
8
- ③ Registration Mast
A:With Boss B:Without Boss
- ④ Height:
300=3.00mm
- ⑤ Packing
A:Tray
T:Tube
R:Tape&Reel
- ⑥ Series Number:
034

Unless Otherwise specified tolerance
 X. ±0.35 X.XX: ±0.20
 X.X: ±0.25 X.XXX: ±0.15

Antenk ANTENK ELECTRONICS CO., LTD
[Http://www.antenk.com](http://www.antenk.com)
 E-mail:sales@antenk.com

SCALE: As Shown	UNIT: mm
DRAW ZLA	DATE 22/02/2022
CHECK BobYang	DATE 22/02/2022

TITLE:
Dual SIM CARD 8PIN H3.0mm Connector



DRAWING NO: ATK-SIM-8-B-300-A-034
 PRODUCT NO: ATK-SIM-8-B-300-A-034

REV	DESCRIPTION	DATE